

0.1-10 keV





15 keV-10 MeV

Simbol-X

A formation flying mission for hard X-ray astrophysics

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(on behalf of a large collaboration of French, I talian & German researchers)

SIMBOL-X

The 10 keV sensitivity gap reason

XMM-Newton





0.1-10 keV : focusing optics Spatial resolution : 15 arcsec High signal to noise INTEGRAL





15 keV-10 MeV : coded masks Spatial resolution : 12 arcmin Moderate signal to noise

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SIMBOL-X telescope: driving design criteria

 use of high density materials coatings or multilayer mirrors increase of the reflection angles)

possibility to use the Ni replication technology for <u>monolithic</u> optics
 (> already available and consolidated technology)

 maximum diameter compatible with the standard superpolishing techniques already used for XMM

 Iow reflecting angles but, at the same time, large collecting areas → Iong focal length

the Formation Flight architecture allow us to implement this concept!

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The way to go : extend focusing into hard X-rays domain

Simbol-X proposal, basically : long focal length telescope, using grazing incidence X-ray optics, with mirror and detectors mounted on two different spacecraft in formation flying







Optics & coating • Heritage from XMM-Newton : nickel shells obtained by electroforming replication method; low mass obtained via a reduced thickness of shells 700 500 SIMBOL-X 30 m focal length Multi-layer Pt/C coating 600 100⊨ SIMBOL-X 500 Effective area (cm²) Pt coating 50 F Focal length = 30 m400 cm2 300 10⊨ 5 F **Dq** : ~ 30" HEW 200 FOV : ~ 6 arcmin XMM 100 580 cm² @ 30 keV 1 mirror 1 Ξ 0.5 0 60 80 0 20 40 20 50 70 80 10 30 40 60 90 100 0 Energy (keV) Energy (keV) Shell diameters : 290 to 600 mm Same parameters except for coating, Angles : Pt/C multi layer 0.07° to 0.142° Shell thickness : 0.12 to 0.30 mm Strong increase of response above 40 keV Number of shells : 100 Small increase of field of view : 7 arcmin Pt coating Total mass : 213 kg

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Optics, shorter focal length option



- Strong increase of FOV and gain in plate scale, but less effective area above 25 keV, compensated by a smaller focal spot (→ less background counts)
- Trade-off to be performed between FOV, effective area, and mission constraints during phase A

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Simbol-X "nominal" characteristics and potential improvements

Pt coating

Energy range :	0.5-70	0.5 - 80 keV
Resolution : keV	~ 130 eV @ 6 ~ 2 keV @ 60 keV	1 keV @ 60 keV
Angular resol. :	< 30 arcsec (local. < 3 arcsec) goal 15 arcsec	
Field of View :	6 arcmin	7 - 12 arcmin
Effective area :	<pre>> 550 cm² E < 35 keV 150 cm² @ 50 keV 2 cm² @ 70</pre>	200 cm ² @ 70
keV		
Sensitivity :	$10^{-8} \text{ ph/cm}^2/\text{s/keV}$ (E < 40 keV) (3 s, 1 Ms, DE =	up to ~ 80 keV
E/2)		

Multi-layer

Mirror thermal control and low energy limit

- If mirror fully open to space (2 sides), then a very strong thermal control is needed, with ~ 200 W of heating power, and potential difficulties to ensure necessary homogeneity
- Thermal problem is much relaxed (down to ~ 20 W) by closing mirror apertures with a single foil (on each side) of insulating material
- But cost : loss of very low energies



Focal plane





Active anticoincidence
Optical filter (0.1 mm Al)
Low energy detector (450 mm Silicium)
High energy detector (2 mm Cd(Zn)Te)

Requirements

- Pixel size of ~ 500 mm (gives good oversampling of the few mm PSF)
- Full diameter of focal plane : 6 cm
- Fast response detectors for full anticoincidence scheme
- Operation at "room" temperature
- Low energy response down to ~ 1 keV
- Good spectral resolution for I ron line

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High Energy Detector : R&D in CEA (CNES funded)

- Tests pixellated Cd(Zn)Te matrices
- ASICs development (IDeF-X Vx.x)
- Hybridization

256 pixels CZT array, 6 mm thick (eV-Products)







256 pixels Schottky arrays, 0.5 mm thick (ACRORAD)

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R&D in CEA, first light of IDeF-X V1.0



Low energy detector

Silicon Drift Detector matrix with integrated DEPFET





- Low power consumption
- Internal amplification
- Room temperature operations
- Active Pixel Sensor type
- 100 % filling factor
- Adjustable pixel size (50 mm to 1 mm)
- Fast, parallel readout possible



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0

1000

2000

3000

4000

Energy (eV)

5000

6000

7000

Collimator & sky-shield optimization



To obtain ~1¹⁰⁻⁴ cts cm-2 s-1 keV-1 the collimator FOV must be < 3°

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Flux sensitivity



X-ray imaging test of a thin JET-X mirror shell



• diam. = 30 cm

• thickness = $130 \,\mu m$

• wall thickness **8.5** *times* less than JET-X and **3.4** *times* less than XMM



HEW_{meas} = 25 arcsec

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Simbol-X : conclusion and next phases

- Results of assessment phase : Simbol-X is mature, and well in the 30 % required margin in this study phase (total mass 2.2 tons with all system and sub-system margins, for a Soyuz capability of 2.3 tons) → talk by R. Cledassou
- No show-stoppers identified neither for the formation flying, nor for the payload
- Selection for phase A (2 missions) in October 2005
- End of phase A, and selection of the flying mission : end 2006
- Launch date for Simbol-X : end of 2012
- Operations : 2.5-3 years, with a requirement of 2 full years of science data taking, and over 1000 targets possible

• Expression of a strong interest of ASI for a large involvement in the mission. Discussions under finalization between CNES and ASI for doing a common phase A.

July – September 2005: Scientific topics and requirement document prepared by representative of the French & Italian community with the endorsement of ASI & CNES → very important to fix a common baseline for pursuing the Phase A study

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